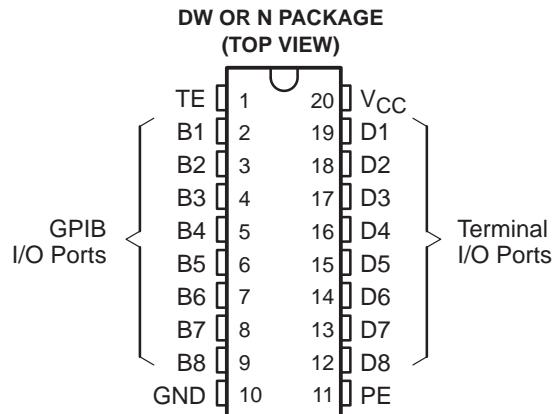


- Suitable for IEEE Standard 488-1978 (GPIB)
- 8-Channel Bidirectional Transceivers
- High-Speed Advanced Low-Power Schottky (ALS) Circuitry
- Low Power Dissipation . . . 46 mW Max Per Channel
- Fast Propagation Times . . . 20 ns Max
- High-Impedance pnp Inputs
- Receiver Hysteresis . . . 650 mV Typ
- Open-Collector Driver Output Option
- No Loading of Bus When Device Is Powered Down ($V_{CC} = 0$)
- Power-Up/Power-Down Protection (Glitch Free)



description/ordering information

The SN75ALS160 eight-channel general-purpose interface bus transceivers are monolithic, high-speed, advanced low-power Schottky (ALS) devices designed for two-way data communications over single-ended transmission lines. This device is designed to meet the requirements of IEEE Standard 488-1978. The transceivers feature driver outputs that can be operated in either the passive-pullup or 3-state mode. If talk enable (TE) is high, these ports have the characteristics of passive-pullup outputs when pullup enable (PE) is low and of 3-state outputs when PE is high. Taking TE low places these ports in the high-impedance state. The driver outputs are designed to handle loads up to 48 mA of sink current.

An active turn-off feature has been incorporated into the bus-terminating resistors so that the device exhibits a high impedance to the bus when $V_{CC} = 0$. When combined with the SN75ALS161 or SN75ALS162 bus management transceiver, the pair provides the complete 16-wire interface for the IEEE-488 bus.

The SN75ALS160 is characterized for operation from 0°C to 70°C.

ORDERING INFORMATION

T_A	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP (N)	Tube of 20	SN75ALS160N	SN75ALS160
	SOIC (DW)	Tube of 25	SN75ALS160DW	75ALS160
		Reel of 2000	SN75ALS160DWR	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SN75ALS160 OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

SLLS018E – JUNE 1986 – REVISED JUNE 2004

Function Tables

EACH DRIVER

INPUTS			OUTPUT
D	TE	PE	B
H	H	H	H
L	H	X	L
H	X	L	Z†
X	L	X	Z†

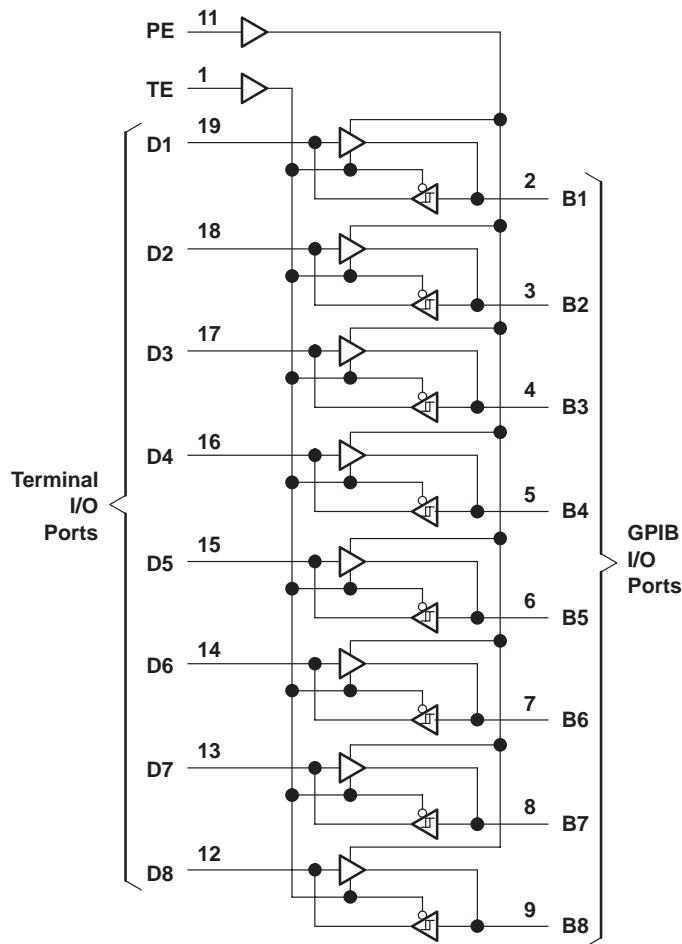
EACH RECEIVER

INPUTS			OUTPUT
B	TE	PE	D
L	L	X	L
H	L	X	H
X	H	X	Z

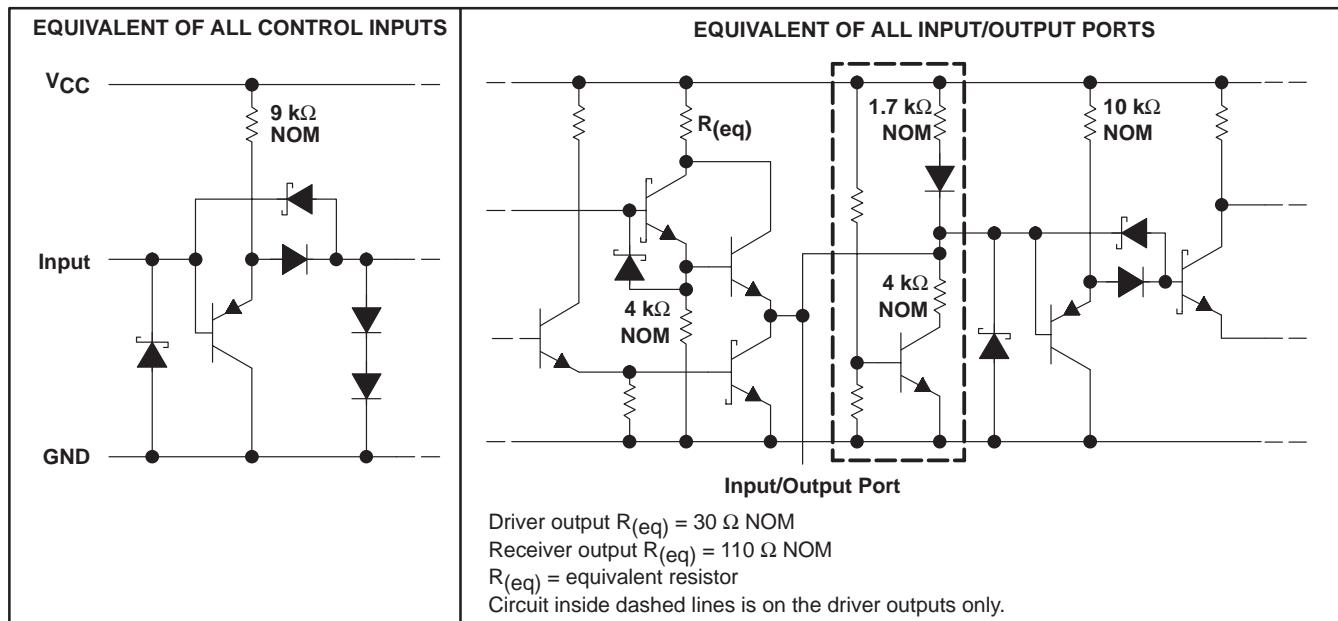
H = high level, L = low level, X = irrelevant,
Z = high-impedance state

† This is the high-impedance state of a
normal 3-state output modified by the
internal resistors to V_{CC} and GND.

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage, V_I	5.5 V
Low-level driver output current, I_{OL}	100 mA
Package thermal impedance, θ_{JA} (see Notes 2 and 3): DW package	58°C/W
	N package
Operating virtual junction temperature, T_J	150°C
Storage temperature range, T_{stg}	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to network ground terminal.

- Maximum power dissipation is a function of $T_J(\max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- The package thermal impedance is calculated in accordance with JESD 51-7.

SN75ALS160

OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

SLLS018E – JUNE 1986 – REVISED JUNE 2004

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		4.75	5	5.25	V
V_{IH}	High-level input voltage		2			V
V_{IL}	Low-level input voltage				0.8	V
I_{OH}	High-level output current	Bus ports with pullups active			-5.2	mA
		Terminal ports			-800	μ A
I_{OL}	Low-level output current	Bus ports			48	mA
		Terminal ports			16	
T_A	Operating free-air temperature		0		70	$^{\circ}$ C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]		MIN	TYP [‡]	MAX	UNIT	
V_{IK}	Input clamp voltage	$I_I = -18$ mA	$V_{CC} = \text{MIN}$		-0.8	-1.5	V	
V_{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)	Bus		0.4	0.65		V	
$V_{OH}^{\$}$	High-level output voltage	Terminal	$I_{OH} = -800$ μ A, TE at 0.8 V, $V_{CC} = \text{MIN}$	2.7	3.5		V	
		Bus	$I_{OH} = -5.2$ mA, PE and TE at 2 V, $V_{CC} = \text{MIN}$	2.5	3.3			
V_{OL}	Low-level output voltage	Terminal	$I_{OL} = 16$ mA, TE at 0.8 V, $V_{CC} = \text{MIN}$	0.3	0.5		V	
		Bus	$I_{OL} = 48$ mA, TE at 2 V, $V_{CC} = \text{MIN}$	0.35	0.5			
I_I	Input current at maximum input voltage	Terminal	$V_I = 5.5$ V, $V_{CC} = \text{MAX}$		0.2	100	μ A	
I_{IH}	High-level input current	Terminal, PE, or TE	$V_I = 2.7$ V, $V_{CC} = \text{MAX}$		0.1	20	μ A	
I_{IL}	Low-level input current	Terminal, PE, or TE	$V_I = 0.5$ V, $V_{CC} = \text{MAX}$		-10	-100	μ A	
$V_{I/O(bus)}$	Voltage at bus port		$I_I(\text{bus}) = 0$	2.5	3	3.7	V	
			$I_I(\text{bus}) = -12$ mA			-1.5		
$I_{I/O(bus)}$	Current into bus port	Power on	$V_I(\text{bus}) = -1.5$ V to 0.4 V		-1.3		mA	
			$V_I(\text{bus}) = 0.4$ V to 2.5 V		0	-3.2		
			$V_I(\text{bus}) = 2.5$ V to 3.7 V			2.5		
			$V_I(\text{bus}) = 3.7$ V to 5 V		0	2.5		
			$V_I(\text{bus}) = 5$ V to 5.5 V		0.7	2.5		
		Power off	$V_{CC} = 0$	$V_I(\text{bus}) = 0$ to 2.5 V		40	μ A	
I_{OS}	Short-circuit output current	Terminal	$V_{CC} = \text{MAX}$		-15	-35	-75	mA
		Bus	$V_{CC} = \text{MAX}$		-25	-50	-125	
I_{CC}	Supply current	No load, $V_{CC} = \text{MAX}$	Terminal outputs low and enabled		42	65		mA
			Bus outputs low and enabled		52	80		
$C_{I/O(bus)}$	Bus-port capacitance	$V_{CC} = 0$ to 5 V,	$V_{I/O} = 0$ to 2 V, $f = 1$ MHz		30		pF	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5$ V, $T_A = 25^{\circ}$ C.

^{\$} V_{OH} applies to 3-state outputs only.

switching characteristics at $V_{CC} = 4.75$ V, 5 V, and 5.25 V, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP†	MAX	UNIT
t _{PLH} Propagation delay time, low- to high-level output	Terminal	Bus	See Figure 1, $C_L = 50$ pF	10	17		ns
t _{PHL} Propagation delay time, high- to low-level output				10	14		
t _{PLH} Propagation delay time, low- to high-level output	Bus	Terminal	See Figure 2, $C_L = 50$ pF	8	15		ns
t _{PHL} Propagation delay time, high- to low-level output				8	15		
t _{PZH} Output enable time to high level	TE	Bus	See Figure 3, $C_L = 50$ pF	24	30		ns
t _{PHZ} Output disable time from high level				9	14		
t _{PZL} Output enable time to low level				16	28		
t _{PLZ} Output disable time from low level				12	19		
t _{PZH} Output enable time to high level	TE	Terminal	See Figure 4, $C_L = 50$ pF	24	36		ns
t _{PHZ} Output disable time from high level				10	18		
t _{PZL} Output enable time to low level				15	26		
t _{PLZ} Output disable time from low level				15	24		
t _{ten} Output pullup enable time	PE	Bus	See Figure 5, $C_L = 50$ pF	16	24		ns
t _{tdis} Output pullup disable time				9	16		

† All typical values are at $V_{CC} = 5$ V.

switching characteristics over recommended range of operating free-air temperature, $V_{CC} = 5$ V

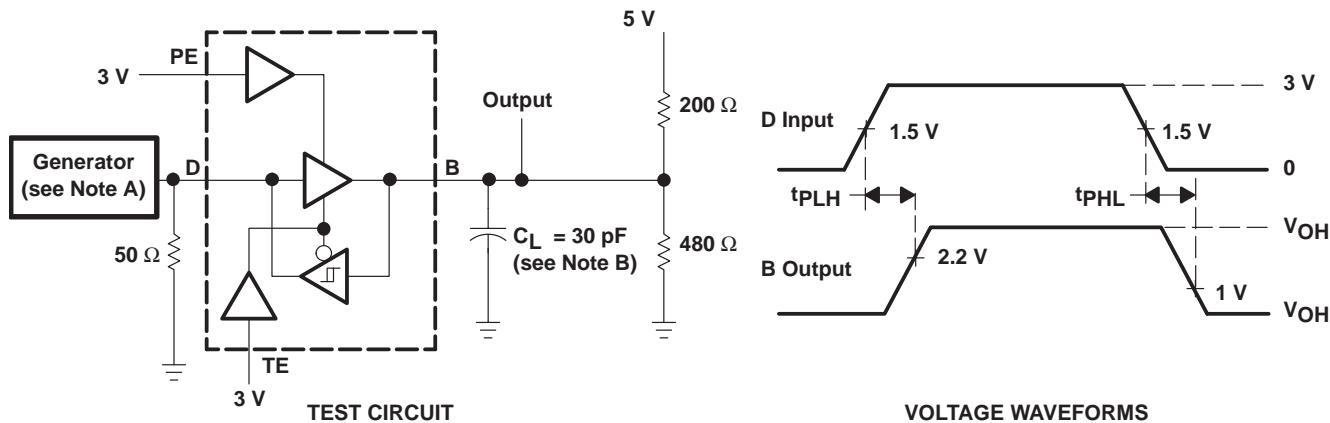
PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
t _{PLH} Propagation delay time, low- to high-level output	Terminal	Bus	$C_L = 30$ pF, See Figure 1	7	20		ns
t _{PHL} Propagation delay time, high- to low-level output				8	20		
t _{PLH} Propagation delay time, low- to high-level output	Bus	Terminal	$C_L = 30$ pF, See Figure 2	7	14		ns
t _{PHL} Propagation delay time, high- to low-level output				9	14		
t _{PZH} Output enable time to high level	TE	Bus	$C_L = 15$ pF, See Figure 3	19	30		ns
t _{PHZ} Output disable time from high level				5	12		
t _{PZL} Output enable time to low level				16	35		
t _{PLZ} Output disable time from low level				9	20		
t _{PZH} Output enable time to high level	TE	Terminal	$C_L = 15$ pF, See Figure 4	13	30		ns
t _{PHZ} Output disable time from high level				12	20		
t _{PZL} Output enable time to low level				12	20		
t _{PLZ} Output disable time from low level				11	20		
t _{ten} Output pullup enable time	PE	Bus	$C_L = 15$ pF, See Figure 5	11	22		ns
t _{tdis} Output pullup disable time				6	12		

‡ Typical values are at $T_A = 25^\circ\text{C}$.

SN75ALS160 OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

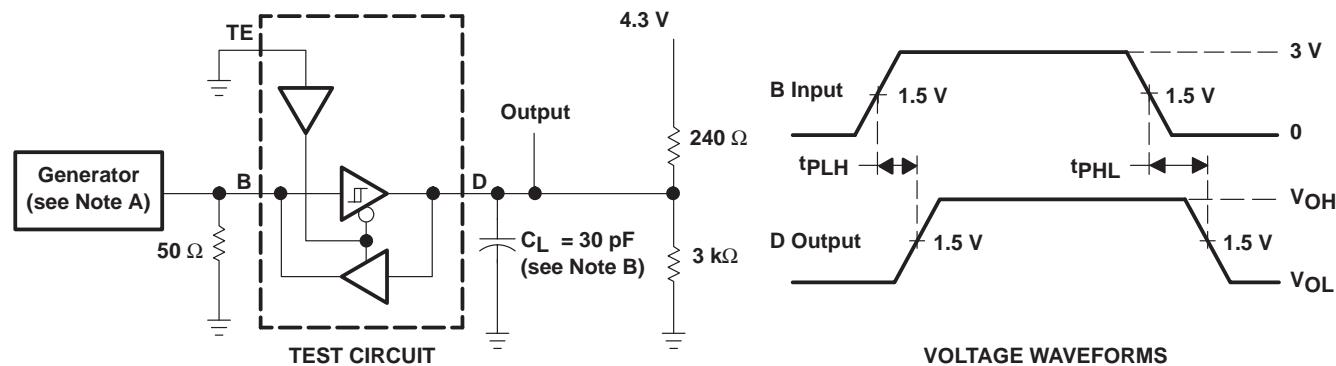
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PARAMETER MEASUREMENT INFORMATION



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_O = 50 \Omega$.
 B. C_L includes probe and jig capacitance.

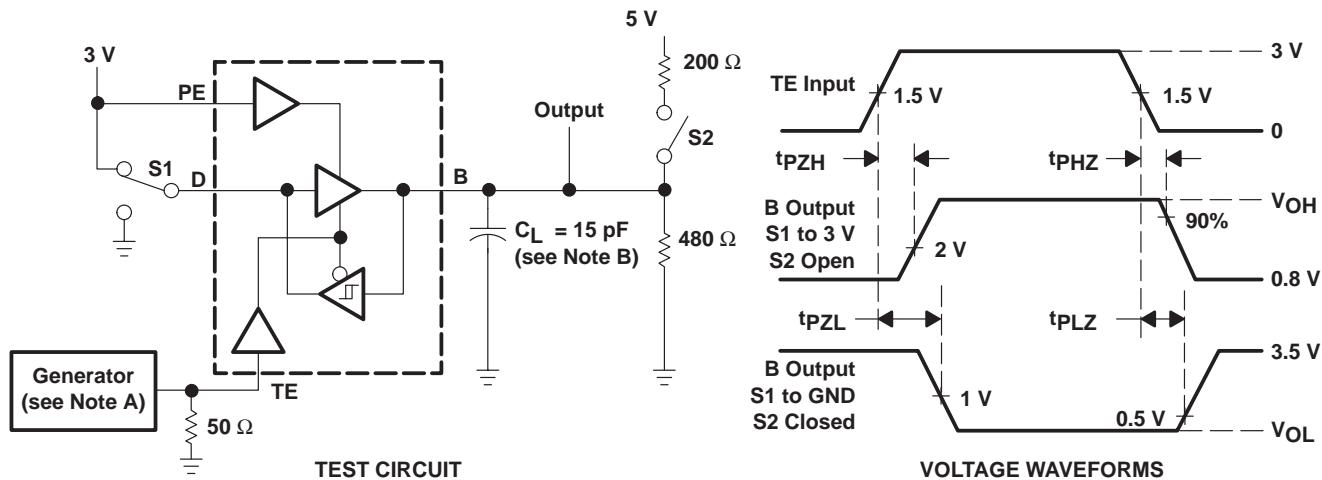
Figure 1. Terminal-to-Bus Test Circuit and Voltage Waveforms



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_O = 50 \Omega$.
 B. C_L includes probe and jig capacitance.

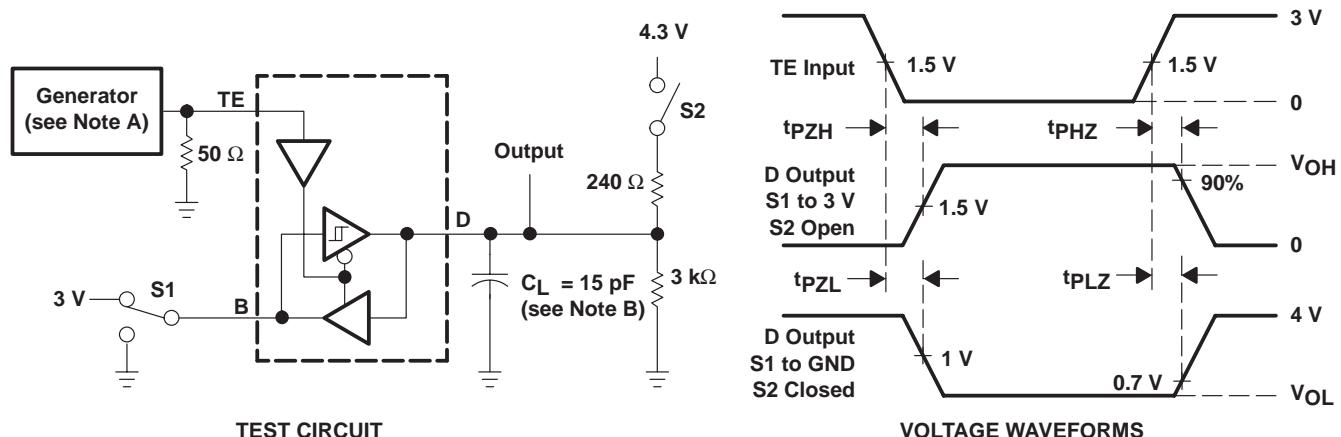
Figure 2. Bus-to-Terminal Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_0 = 50 \Omega$.
B. C_L includes probe and jig capacitance.

Figure 3. TE-to-Bus Test Circuit and Voltage Waveforms



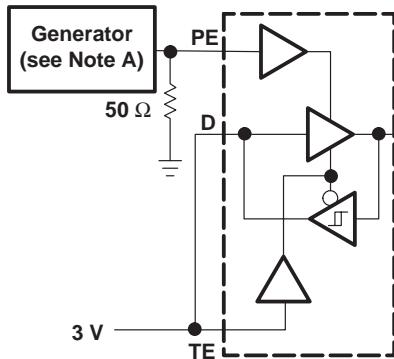
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_0 = 50 \Omega$.
B. C_L includes probe and jig capacitance.

Figure 4. TE-to-Terminal Test Circuit and Voltage Waveforms

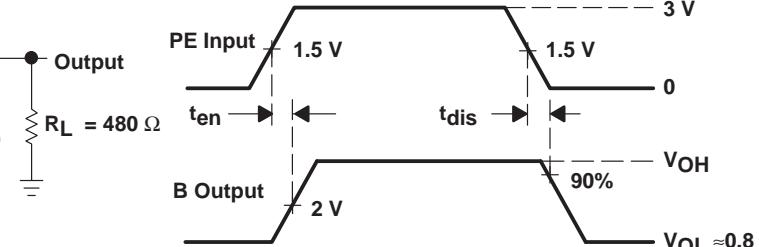
SN75ALS160 OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

SLLS018E – JUNE 1986 – REVISED JUNE 2004

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_O = 50 \Omega$.
 B. C_L includes probe and jig capacitance.

Figure 5. PE-to-Bus Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

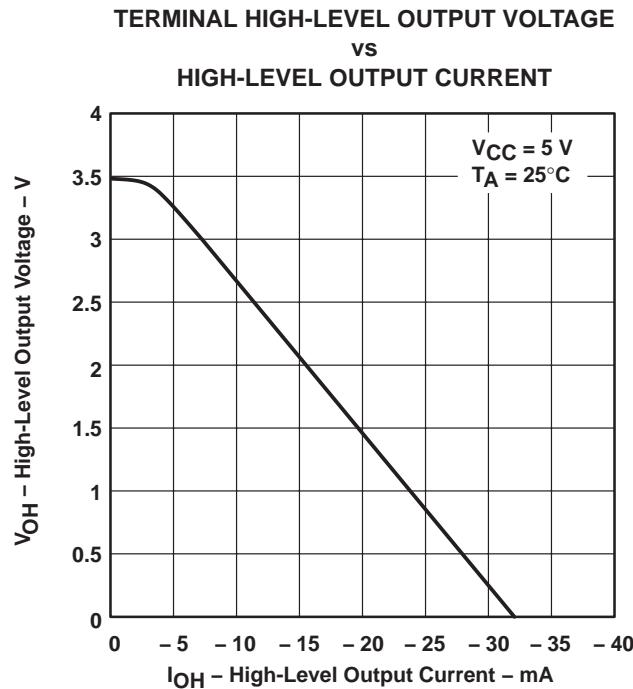


Figure 6

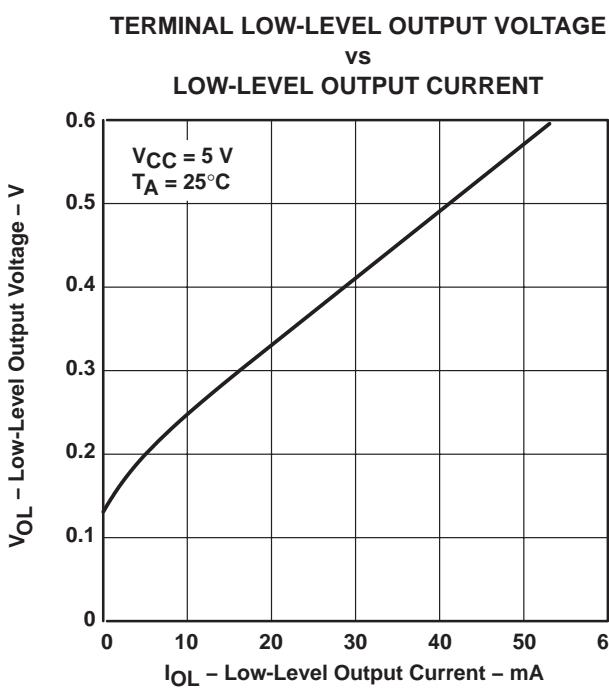


Figure 7

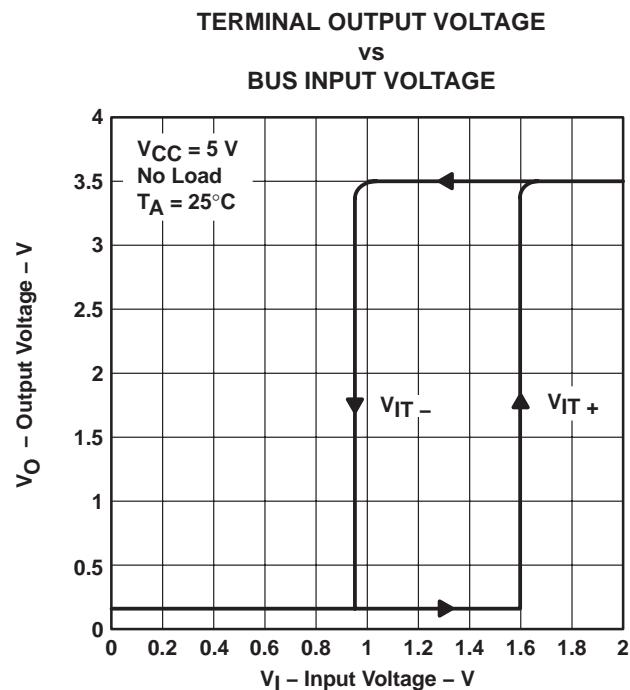


Figure 8

SN75ALS160

OCTAL GENERAL-PURPOSE INTERFACE BUS TRANSCEIVERS

SLLS018E – JUNE 1986 – REVISED JUNE 2004

TYPICAL CHARACTERISTICS

BUS HIGH-LEVEL OUTPUT VOLTAGE
vs
BUS HIGH-LEVEL OUTPUT CURRENT

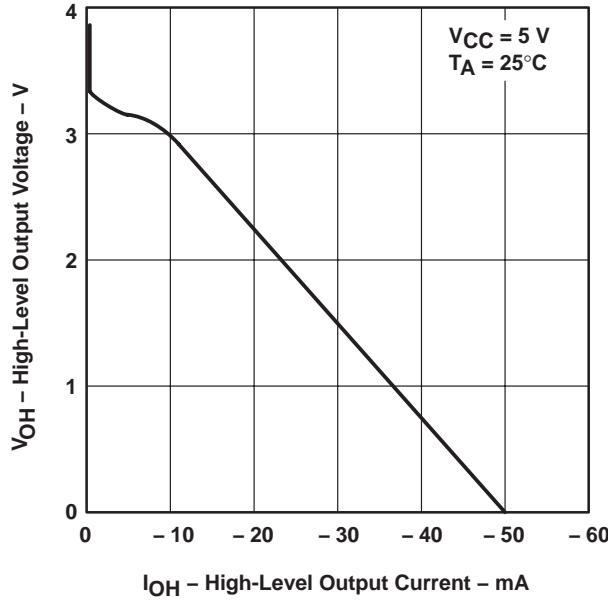


Figure 9

BUS LOW-LEVEL OUTPUT VOLTAGE
vs
BUS LOW-LEVEL OUTPUT CURRENT

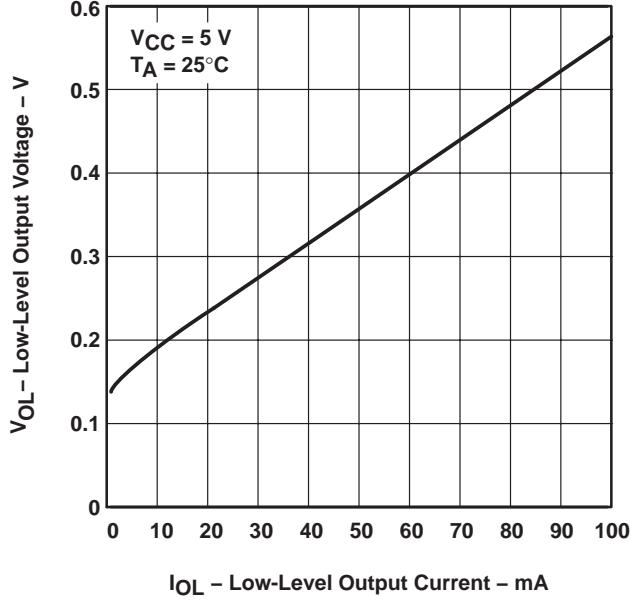


Figure 10

BUS OUTPUT VOLTAGE
vs
TERMINAL INPUT VOLTAGE

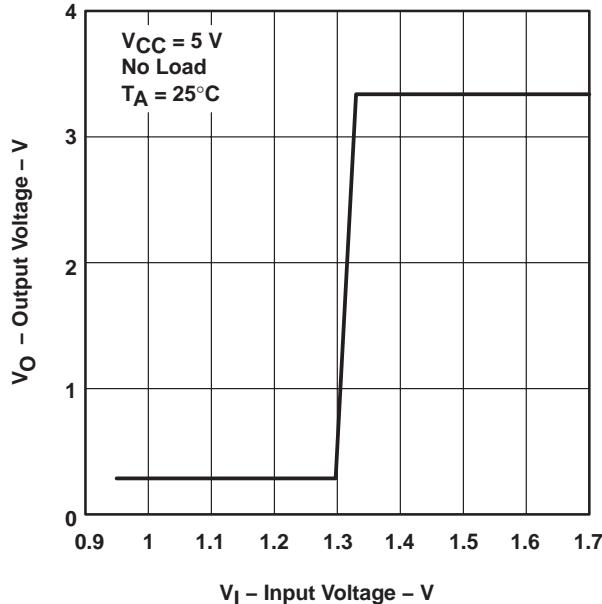


Figure 11

BUS CURRENT
vs
BUS VOLTAGE

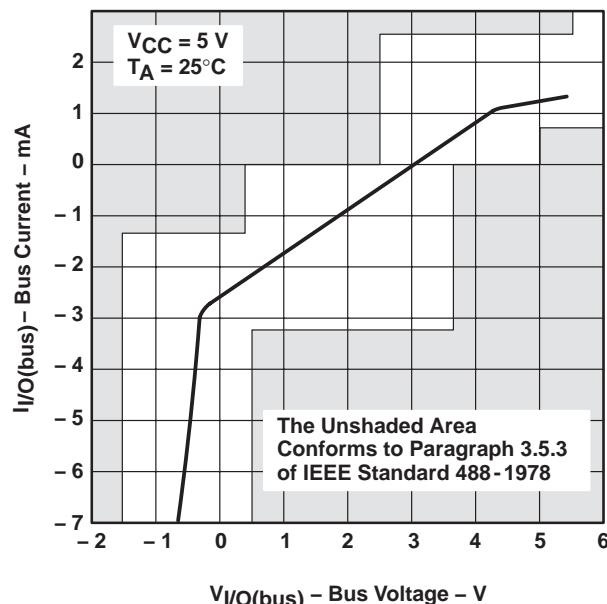


Figure 12

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN75ALS160DW	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DW.A	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DWE4	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DWR	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DWR.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DWRG4	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160DWRG4.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS160
SN75ALS160N	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75ALS160N
SN75ALS160N.A	Active	Production	PDIP (N) 20	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75ALS160N

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

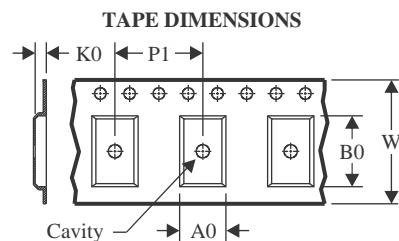
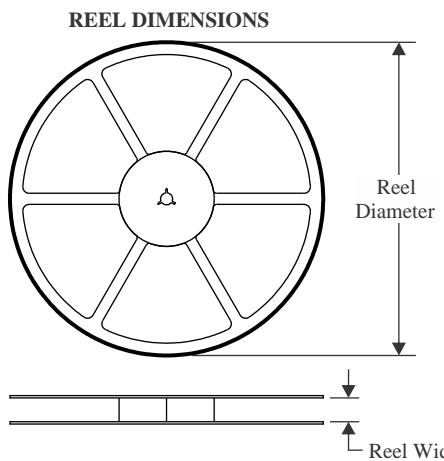
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN75ALS160 :

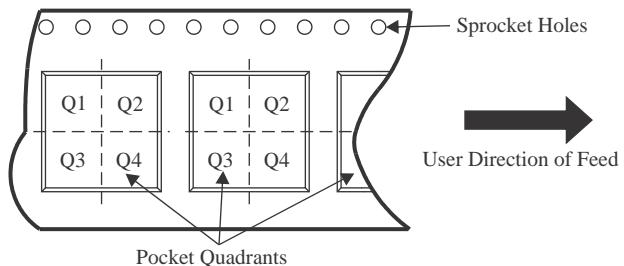
- Military : [SN55ALS160](#)

NOTE: Qualified Version Definitions:

- Military - QML certified for Military and Defense Applications

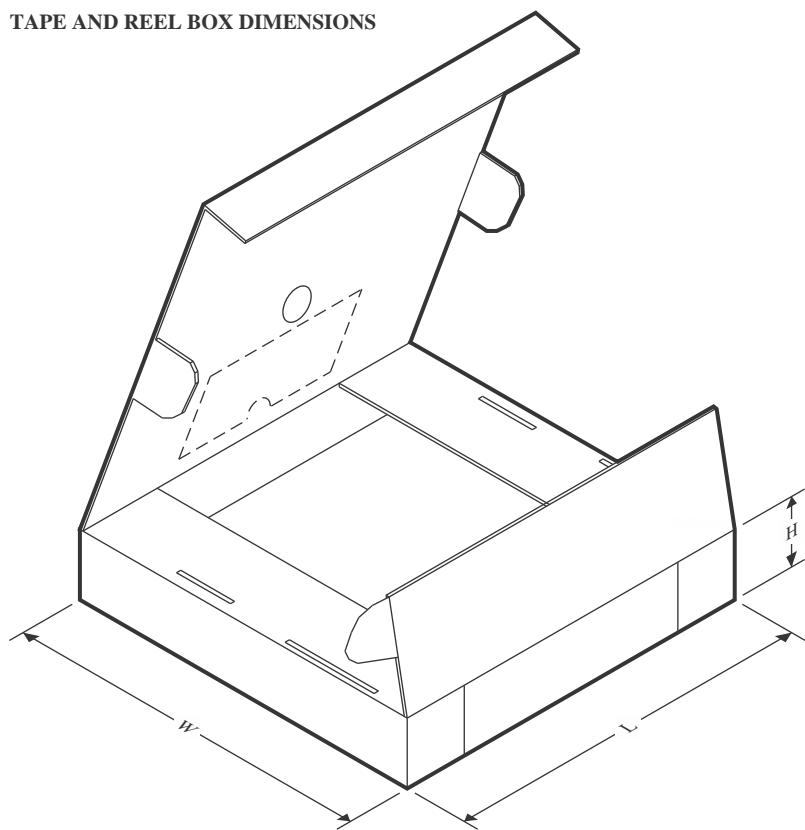
TAPE AND REEL INFORMATION


A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


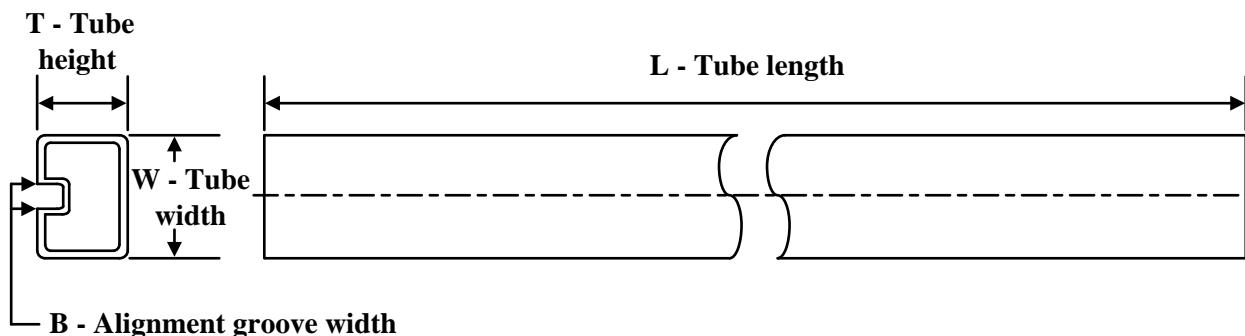
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS160DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN75ALS160DWRG4	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS160DWR	SOIC	DW	20	2000	356.0	356.0	45.0
SN75ALS160DWG4	SOIC	DW	20	2000	356.0	356.0	45.0

TUBE


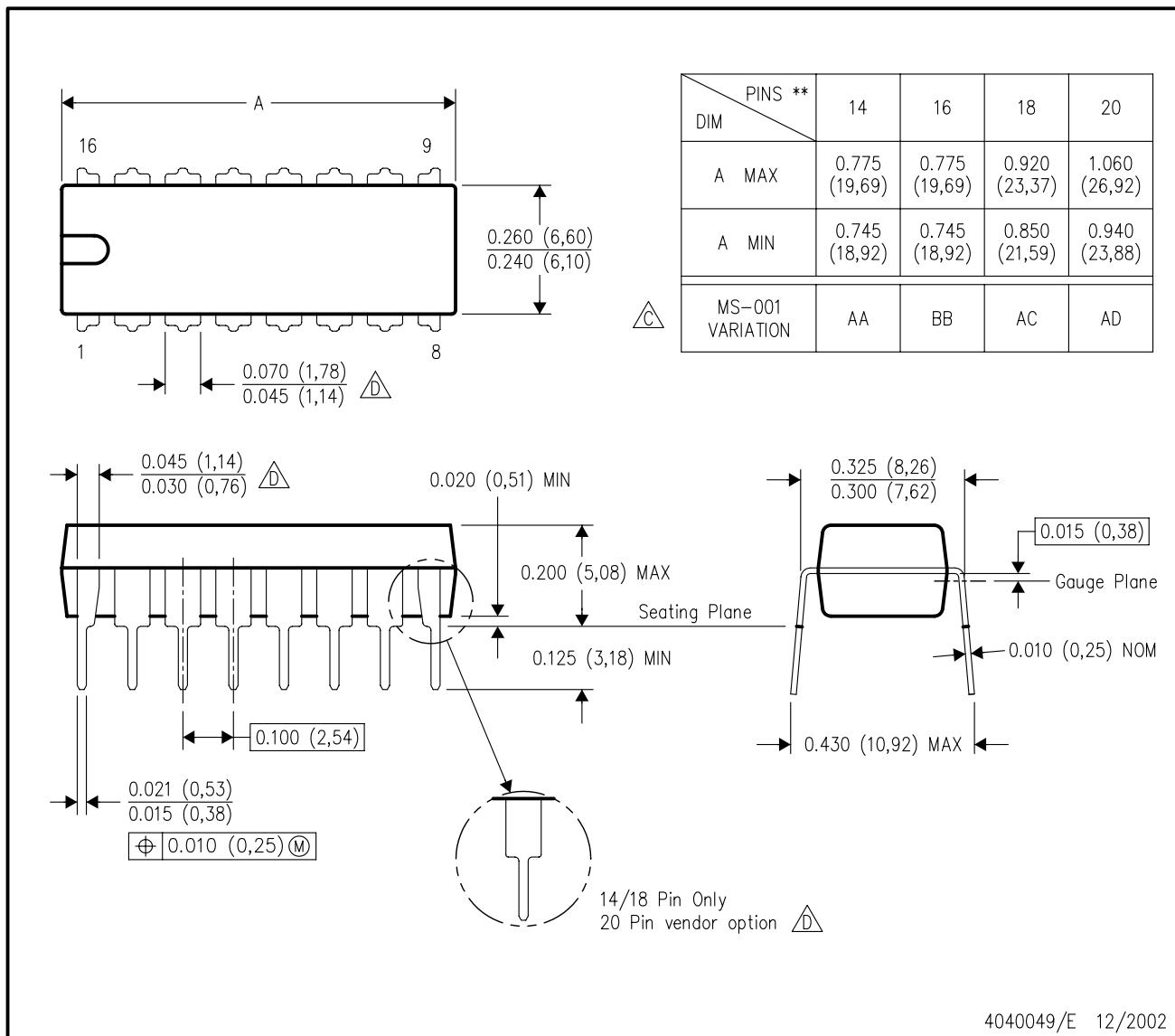
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN75ALS160DW	DW	SOIC	20	25	507	12.83	5080	6.6
SN75ALS160DW	DW	SOIC	20	25	506.98	12.7	4826	6.6
SN75ALS160DW.A	DW	SOIC	20	25	506.98	12.7	4826	6.6
SN75ALS160DW.A	DW	SOIC	20	25	507	12.83	5080	6.6
SN75ALS160DWE4	DW	SOIC	20	25	507	12.83	5080	6.6
SN75ALS160DWE4	DW	SOIC	20	25	506.98	12.7	4826	6.6
SN75ALS160N	N	PDIP	20	20	506	13.97	11230	4.32
SN75ALS160N.A	N	PDIP	20	20	506	13.97	11230	4.32

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

△ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

△ The 20 pin end lead shoulder width is a vendor option, either half or full width.

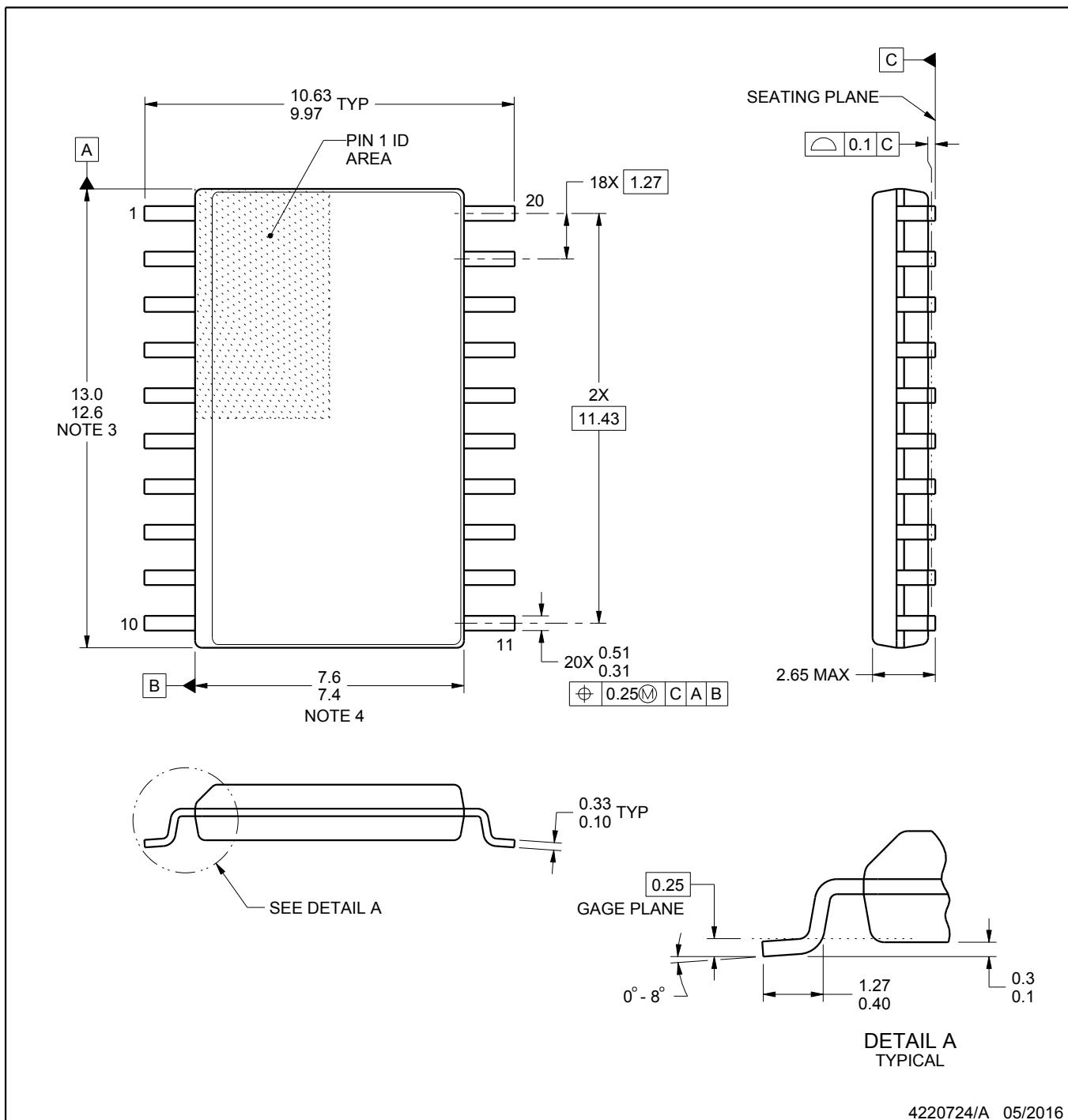
PACKAGE OUTLINE

DW0020A



SOIC - 2.65 mm max height

SOIC



NOTES:

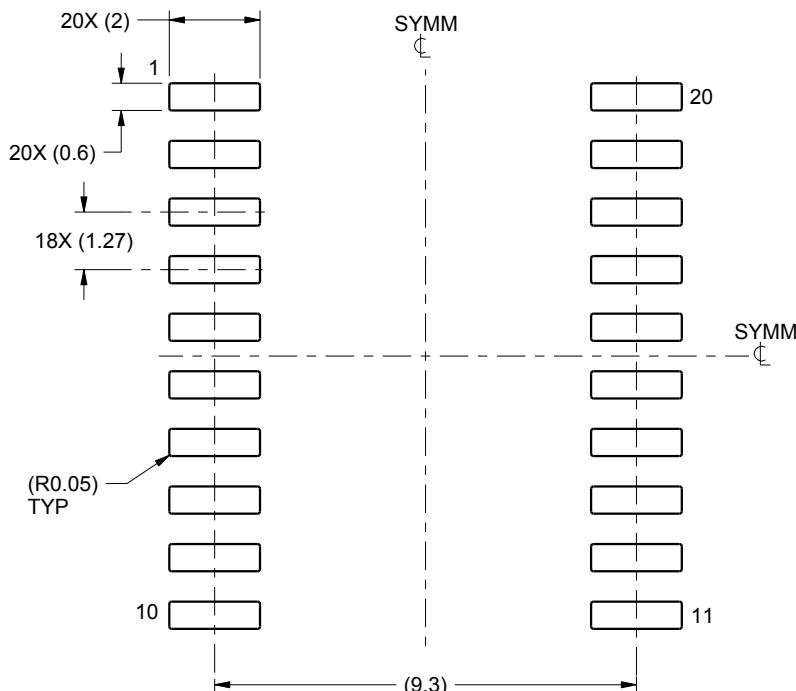
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

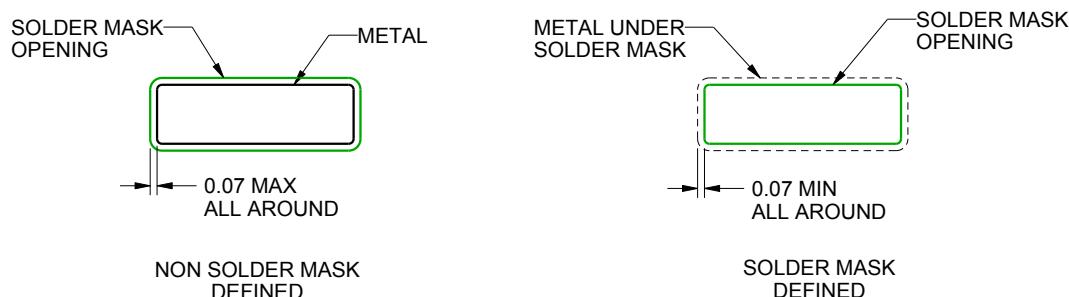
DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

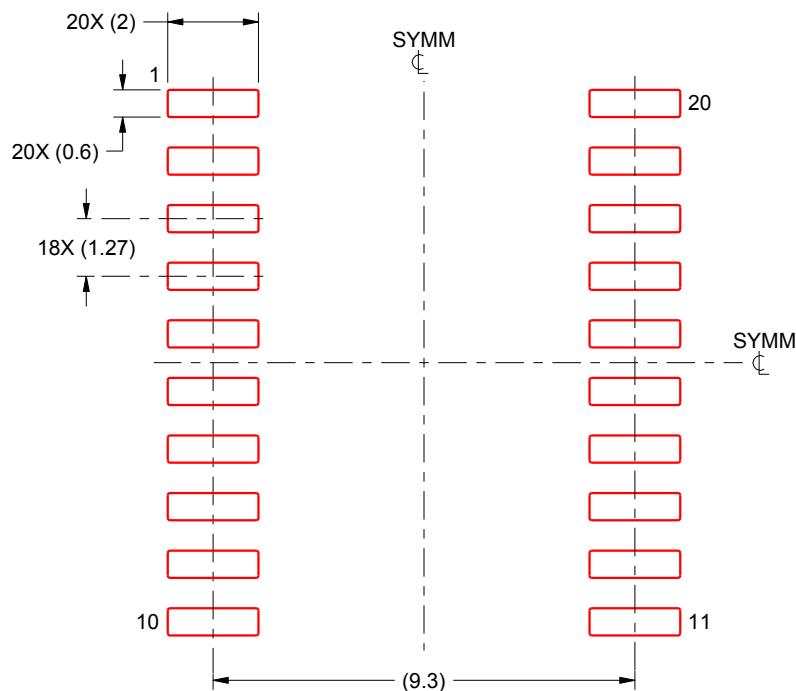
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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